

Radar Receive Path AFE: 4-Channel LNA/PGA/AAF with ADC

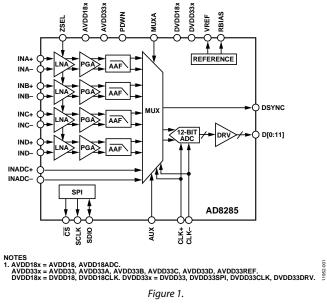
Data Sheet

AD8285

FEATURES

4 channel LNA, PGA, and AAF 1 direct-to-ADC channel Programmable gain amplifier (PGA) Includes low noise preamplifier (LNA) Serial peripheral interface (SPI) programmable gain 16 dB to 34 dB in 6 dB steps Antialiasing filter (AAF) Programmable third-order, low-pass elliptic filter (LPF) from 1.0 MHz to 12.0 MHz Analog-to-digital converter (ADC) 12 bits of accuracy up to 72 MSPS Signal-to-noise ratio (SNR): 68.5 dB Spurious-free dynamic range(SFDR): 68 dB at gain = 16 dB Low power: 185 mW per channel at 12 bits and 72 MSPS Low noise: 3.5 nV/√Hz maximum of input referred voltage noise Power-down mode 72-lead, 10 mm × 10 mm LFCSP package Specified from -40°C to +105°C **Qualified for automotive applications**

FUNCTIONAL BLOCK DIAGRAM



APPLICATIONS

Automotive radar Adaptive cruise control Collision avoidance Blind spot detection Self parking Electronic bumper

GENERAL DESCRIPTION

The AD8285 is designed for low cost, low power, compact size, flexibility, and ease of use. It contains four channels of a low noise preamplifier (LNA) with a programmable gain amplifier (PGA) and an antialiasing filter (AAF) plus one direct-to-ADC channel, all integrated with a single 12-bit analog-to-digital converter (ADC).

Each channel features a gain range of 16 dB to 34 dB in 6 dB increments and an ADC with a conversion rate of up to 72 MSPS. The combined input referred noise voltage of the entire channel

is 3.5 nV/ $\sqrt{\text{Hz}}$ at maximum gain. The channel is optimized for dynamic performance and low power in applications where a small package size is critical.

Fabricated in an advanced complementary metal oxide semiconductor (CMOS) process, the AD8285 is available in a 10 mm \times 10 mm, RoHS compliant, 72-lead LFCSP that is specified over the automotive temperature range of -40° C to $+105^{\circ}$ C.

Rev. 0

Document Feedback

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REVISION HISTORY

5/14—Revision 0: Initial Version

SPECIFICATIONS

AC SPECIFICATIONS

AVDD18 = AVDD18ADC = 1.8 V, AVDD33 = AVDD33x¹ = AVDD33REF = 3.3 V, DVDD18 = DVDD18CLK = 1.8 V, DVDD33SPI = DVDD33CLK = DVDD33DRV = 3.3 V, 1.024 V internal ADC reference, f_{IN} = 2.5 MHz, f_{SAMPLE} = 72 MSPS, R_S = 50 Ω , LNA + PGA gain = 34 dB, LPF cutoff = $f_{SAMPLECH}/4$, full channel mode, 12-bit operation, temperature = -40° C to $+105^{\circ}$ C, unless otherwise noted.

Parameter ²	Test Conditions/Comments	Min	Тур	Max	Unit
ANALOG CHANNEL CHARACTERISTICS	LNA, PGA, and AAF channels				
Gain			16/22/28/34		dB
Gain Range			18		dB
Gain Error		-1.25		+1.25	dB
Input Voltage Range	Channel gain = 16 dB		0.25		V р-р
	Channel gain = 22 dB		0.125		Vp-p
	Channel gain = 28 dB		0.0625		Vp-p
	Channel gain = 34 dB		0.03125		Vp-p
Input Resistance	200 Ω input impedance selected	0.180	0.230	0.280	kΩ
	200 k Ω input impedance selected	160	200	240	kΩ
Input Capacitance			22		рF
Input Referred Voltage Noise	Maximum gain at 1 MHz		1.85		nV/√H
	Minimum gain at 1 MHz		6.03		nV/√H
Noise Figure	Maximum gain, $R_s = 50 \Omega$, unterminated		7.1		dB
J	Maximum gain, $R_s = R_{IN} = 50 \Omega$		12.7		dB
Output Offset	Gain = 16 dB	-60		+60	LSB
	Gain = 34 dB	-250		+250	LSB
AAF Low-Pass Filter Cutoff	-3 dB, programmable		1.0 to 12.0		MHz
Tolerance	After filter autotune	-10	±5	+10	%
AAF Attenuation in Stop Band	Third-order elliptic filter				,.
	2× cutoff		30		dB
	3× cutoff		40		dB
Group Delay Variation	Filter set at 2 MHz		400		ns
Channel-to-Channel Phase Variation	Frequencies up to -3 dB	-5	±0.5	+5	Degree
	$\frac{1}{4}$ of -3 dB frequency	-1	_0.0	+1	Degree
Channel-to-Channel Gain Matching	Frequencies up to –3 dB	-0.5	±0.1	+0.5	dB
channel to channel dair Matering	$\frac{1}{4}$ of -3 dB frequency	-0.25	±0.1	+0.25	dB
1 dB Compression	Relative to output	0.25	9.8	10.25	dBm
Crosstalk			-70	-55	dBc
POWER SUPPLY			70	55	abe
AVDD18, AVDD18ADC		1.7	1.8	1.9	v
AVDD18, AVDD18ADC AVDD33, AVDD33x ¹ , AVDD33REF		3.1	3.3	3.5	v
DVDD18, DVDD18CLK		1.7	1.8	3.5 1.9	V
	,	3.1	3.3	1.9 3.5	V
DVDD33SPI, DVDD33CLK, DVDD33DRV		5.1	5.5		
AVDD18	Full channel mode Full channel mode			130 130	mA
AVDD33	Full channel mode				mA
DVDD18				22	mA
IDVDD33	Full share alwards, as signal to signal to see the			2	mA
Total Power Dissipation Per Channel	Full channel mode, no signal, typical supply voltage × maximum supply current; excludes output current			185	mW
Power-Down Dissipation			5		mW
Power Supply Rejection Ratio (PSRR)			1.6		mV/V

Parameter ²	Test Conditions/Comments	Min	Тур	Max	Unit
ADC					
Resolution			12		Bits
Maximum Sample Rate			72		MSPS
Signal-to-Noise Ratio (SNR)	$f_{IN} = 1 MHz$		68.5		dB
Signal-to-Noise and Distortion (SINAD)			66		dB
Signal-to-Noise Ratio Full Scale (SNRFS)			68		dB
Differential Nonlinearity (DNL)	Guaranteed no missing codes			1	LSB
Integral Nonlinearity (INL)				10	LSB
Effective Number of Bits (ENOB)			10.67		LSB
ADC OUTPUT CHARACTERISTICS					
Maximum Capacitor Load	Per bit		20		рF
IDVDD33 Peak Current with Capacitor Load	Peak current per bit when driving 20 pF load; can be programmed via the SPI port, if required			40	mA
ADC REFERENCE					
Output Voltage Error	VREF = 1.024 V			±25	mV
Load Regulation	At 1.0 mA, VREF = 1.024 V		2		mV
Input Resistance			6		kΩ
FULL CHANNEL CHARACTERISTICS	LNA, PGA, AAF, and ADC channels				
SNRFS	$f_{IN} = 1 MHz$				
	Gain = 16 dB		68		dB
	Gain = 22 dB		68		dB
	Gain = 28 dB		68		dB
	Gain = 34 dB		66		dB
SINAD	$f_{IN} = 1 MHz$				
	Gain = 16 dB		67		dB
	Gain = 22 dB		68		dB
	Gain = 28 dB		67		dB
	Gain = 34 dB		66		dB
Spurious-Free Dynamic Range (SFDR)	$f_{IN} = 1 MHz$				
	Gain = 16 dB		68		dB
	Gain = 22 dB		74		dB
	Gain = 28 dB		74		dB
	Gain = 34 dB		73		dB
Harmonic Distortion					
Second Harmonic	f _{IN} = 1 MHz at −10 dBFS, gain = 16 dB		-70		dBc
····	$f_{IN} = 1 \text{ MHz at } -10 \text{ dBFS}$, gain = 34 dB		-70		dBc
Third Harmonic	$f_{IN} = 1 \text{ MHz at } -10 \text{ dBFS}$, gain = 16 dB		-66		dBc
	$f_{IN} = 1 \text{ MHz at } -10 \text{ dBFS}, \text{ gain} = 34 \text{ dB}$		-75		dBc
IM3 Distortion	$f_{IN1} = 1 \text{ MHz}, f_{IN2} = 1.1 \text{ MHz}, -1 \text{ dBFS}, \text{gain} = 34 \text{ dB}$		-69		dBc
Gain Response Time			600		ns
Overdrive Recovery Time			200		ns

¹ x stands for A, B, C, or D. ² See the AN-835 Application Note, Understanding High Speed ADC Testing and Evaluation, for a complete set of definitions, and how these tests were completed.

DIGITAL SPECIFICATIONS

AVDD18 = AVDD18ADC = 1.8 V, AVDD33 = AVDD33x¹ = AVDD33REF = 3.3 V, DVDD18 = DVDD18CLK = 1.8 V, DVDD33SPI = DVDD33CLK = DVDD33DRV = 3.3 V, 1.024 V internal ADC reference, f_{IN} = 2.5 MHz, f_{SAMPLE} = 72 MSPS, R_s = 50 Ω , LNA + PGA gain = 34 dB, LPF cutoff = $f_{SAMPLECH}/4$, full channel mode, 12-bit operation, temperature = -40° C to $+105^{\circ}$ C, unless otherwise noted.

Parameter ²	Temperature	Min	Тур	Max	Unit
CLOCK INPUTS (CLK+, CLK–)					
Logic Compliance			CMOS/LVDS/	/LVPECL	
Differential Input Voltage ³	Full	250			mV p-p
Input Common-Mode Voltage	Full		1.2		V
Differential Input Resistance	25°C		20		kΩ
Input Capacitance	25°C		1.5		pF
LOGIC INPUTS (PDWN, SCLK, AUX, MUXA, ZSEL)					
Logic 1 Voltage	Full	1.2		3.6	V
Logic 0 Voltage	Full			0.3	V
Input Resistance	25°C		30		kΩ
Input Capacitance	25°C		0.5		рF
Logic Input (CS)					
Logic 1 Voltage	Full	1.2		3.6	V
Logic 0 Voltage	Full			0.3	V
Input Resistance	25°C		70		kΩ
Input Capacitance	25°C		0.5		pF
LOGIC INPUT (SDIO)					
Logic 1 Voltage	Full	1.2		DVDD33x + 0.3	V
Logic 0 Voltage	Full	0		0.3	V
Input Resistance	25°C		30		kΩ
Input Capacitance	25°C		2		рF
LOGIC OUTPUT (SDIO) ⁴					
Logic 1 Voltage ($I_{OH} = 800 \ \mu A$)	Full	3.0			V
Logic 0 Voltage (I₀∟ = 50 µA)	Full			0.3	V
LOGIC OUTPUT (Dx, DSYNC)					
Logic 1 Voltage ($I_{OH} = 2 \text{ mA}$)	Full	3.0			V
Logic 0 Voltage ($I_{OL} = 2 \text{ mA}$)	Full			0.05	V

¹ x stands for A, B, C, or D.

² See the AN-835 Application Note, Understanding High Speed ADC Testing and Evaluation, for a complete set of definitions, and how these tests were completed.

³ Specified for LVDS and LVPECL only.

⁴ Specified for 13 SDIO pins sharing the same connection.

SWITCHING SPECIFICATIONS

 $AVDD18 = AVDD18ADC = 1.8 \text{ V}, AVDD33 = AVDD33x^1 = AVDD33REF = 3.3 \text{ V}, DVDD18 = DVDD18CLK = 1.8 \text{ V}, DVDD33SPI = DVDD33CLK = DVDD33DRV = 3.3 \text{ V}, 1.024 \text{ V} \text{ internal ADC reference}, f_{IN} = 2.5 \text{ MHz}, f_{SAMPLE} = 72 \text{ MSPS}, R_S = 50 \Omega, LNA + PGA gain = 34 dB, LPF cutoff = f_{SAMPLECH}/4, full channel mode, 12-bit operation, temperature = -40°C to +105°C, unless otherwise noted.$

Parameter ²	Temperature	Min	Тур	Max	Unit
CLOCK	-				
Clock Rate	Full	10		72	MSPS
Clock Pulse Width High (teh) at 72 MSPS	Full		6.94		ns
Clock Pulse Width Low (t_{EL}) at 72 MSPS	Full		6.94		ns
Clock Pulse Width High (t_{EH}) at 40 MSPS	Full		12.5		ns
Clock Pulse Width Low (t_{EL}) at 40 MSPS	Full		12.5		ns
OUTPUT PARAMETERS					
Propagation Delay (t_{PD}) at 72 MSPS	Full	1.5	2.5	5.0	ns
Rise Time (t _R) ³	Full		1.9		ns
Fall Time (t _F) ³	Full		1.2		ns
Data Set-Up Time (t_{DS}) at 72 MSPS	Full	9.0	10.0	11.0	ns
Data Hold Time (t_{DH}) at 72 MSPS	Full	1.5	4.0	5.0	ns
Data Set-Up Time (t _{Ds}) at 40 MSPS	Full	21.5	22.5	23.5	ns
Data Hold Time (t_{DH}) at 40 MSPS	Full	1.5	4.0	5.0	ns
Pipeline Latency	Full		7		Clock cycles

¹ x stands for A, B, C, or D.

² See the AN-835 Application Note, Understanding High Speed ADC Testing and Evaluation, for a complete set of definitions, and how these tests were completed. ³ Not shown in Figure 2.

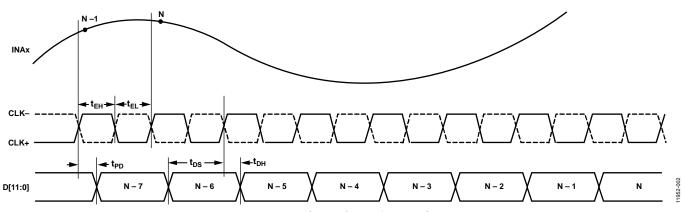


Figure 2. Timing Definitions for Switching Specifications

ABSOLUTE MAXIMUM RATINGS

Table 4.

Tuble I.	
Parameter	Rating
Electrical	
AVDD18x ¹ to GND	–0.3 V to +2.0 V
AVDD33x ² to GND	–0.3 V to +3.5 V
DVDD18x ³ to GND	–0.3 V to +2.0 V
DVDD33x ⁴ to GND	–0.3 V to +3.5 V
Analog Inputs INx+, INx- to GND	–0.3 V to +3.5 V
Auxiliary Inputs INADC+, INADC– to GND	–0.3 V to +2.0 V
Digital Outputs D[11:0], DSYNC, SDIO to GND	–0.3 V to +3.5 V
CLK+, CLK– to GND	–0.3 V to +3.9 V
PDWN, SCLK, CS, AUX, MUXA, ZSEL to GND	–0.3 V to +3.9 V
RBIAS, VREF to GND	–0.3 V to +2.0 V
Environmental	
Operating Temperature Range (Ambient)	–40°C to +105°C
Storage Temperature Range (Ambient)	–65°C to +150°C
Maximum Junction Temperature	150°C
Lead Temperature (Soldering, 10 sec)	300°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

 1 AVDD18x = AVDD18 and AVDD18ADC.

² AVDD33x = AVDD33A, AVDD33B, AVDD33C, AVDD33D, and AVDD33REF.

³ DVDD18x / DVDD18, DVDD18CLK.

⁴ DVDD33x = DVDD33, DVDD33SPI, DVDD33CLK, DVDD33DRV.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

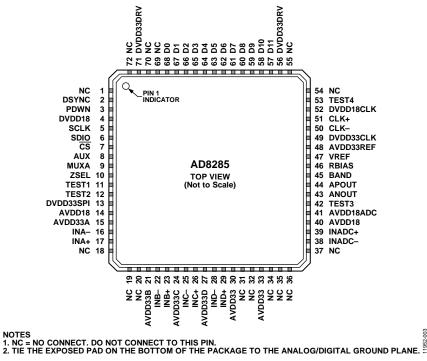


Figure 3. Pin Configuration

Table 5. Pin Function Descriptions

Pin No.	Mnemonic	Description
0	EPAD	Exposed Pad. Tie the exposed pad on the bottom of the package to the analog/digital ground plane.
1	NC	No Connect. Do not connect to this pin.
2	DSYNC	Data Output Synchronization.
3	PDWN	Full Power Down. Logic high overrides the SPI and powers down the device. Logic low allows selection of the power down option through the SPI.
4	DVDD18	1.8 V Digital Supply.
5	SCLK	Serial Clock.
6	SDIO	Serial Data Input/Output.
7	CS	Chip Select Bar.
8	AUX	Auxiliary. A logic high on AUX switches the AUX channel (INADC+/INADC–) to the ADC. The AUX pin has a higher priority than the MUXA pin.
9	MUXA	Channel A Select. Logic high forces to Channel A unless AUX is asserted.
10	ZSEL	Input Impedance Select. Logic high overrides the SPI and sets the input impedance to 200 k Ω . Logic low allows selection of the input impedance through the SPI.
11	TEST1	Test. Do not use the TEST1 pin; tie it to ground.
12	TEST2	Test. Do not use the TEST2 pin; tie it to ground.
13	DVDD33SPI	3.3 V Digital Supply for SPI Port.
14	AVDD18	1.8 V Analog Supply.
15	AVDD33A	3.3 V Analog Supply for Channel A.
16	INA-	Negative LNA Analog Input for Channel A.
17	INA+	Positive LNA Analog Input for Channel A.
18	NC	No Connect. Do not connect to this pin.
19	NC	No Connect. Do not connect to this pin.
20	NC	No Connect. Do not connect to this pin.
21	AVDD33B	3.3 V Analog Supply for Channel B.
22	INB-	Negative LNA Analog Input for Channel B.
23	INB+	Positive LNA Analog Input for Channel B.

Data Sheet

Pin No. Mnemonic Description 24 AVDD33C 3.3 V Analog Supply for Channel C. 25 INC- Negative LNA Analog Input for Channel C. 26 INC- Positive LNA Analog Input for Channel C. 27 AVDD33D 3.3 V Analog Supply for Channel D. 28 IND- Negative LNA Analog Input for Channel D. 29 IND- Positive LNA Analog Input for Channel D. 29 IND- Negative LNA Analog Supply. 30 AVDD33 3.3 V Analog Supply. 31 NC No Connect. Do not connect to this pin. 32 NC No Connect. Do not connect to this pin. 33 VADD33 3.3 V Analog Supply. 34 NC No Connect. Do not connect to this pin. 36 NC No Connect. Do not connect to this pin. 37 NC No Connect. Do not connect to this pin. 38 INADC- Negative Analog Input for Alternate Channel D (ADC Only). 40 AVDD18 1.8 V Analog Supply. 41 AVDD180 1.8 V Analog Supply for ADC.		NA	Description
25INC-Negative LNA Analog Input for Channel C.26INC+Positive LNA Analog Input for Channel D.27AVDD33D3.3V Analog Supply for Channel D.28IND-Negative LNA Analog Input for Channel D.29IND+Positive LNA Analog Input for Channel D.20AVDD333.3V Analog Supply for Channel D.21NCNo Connect. Do not connect to this pin.32NCNo Connect. Do not connect to this pin.33Analog Supply.NC34NCNo Connect. Do not connect to this pin.35NCNo Connect. Do not connect to this pin.36NCNo Connect. Do not connect to this pin.37NCNo Connect. Do not connect to this pin.38INADC-No Connect. Do not connect to this pin.39INADC-No connect. Do not connect to this pin.39INADC-No Sative Analog Input for Alternate Channel D (ADC Only).40AVD181.8V Analog Supply for ADC.41AVDD181.8V Analog Supply for ADC.42TEST3Test. Do not use the TEST3 pin; tie it or ground.43ANOUTAnalog Outputs. The ANOUT pin is for debug purposes only. Leave this pin floating.44APOUTAnalog Outputs. The ANOUT pin is for debug purposes only. Leave this pin floating.45BANDBand Gap Voltage. The BAND pin is for debug purposes only. Leave this pin floating.46APOUTAnalog Outputs. The ANOUT pin is for ground.47VREFVoltage Reference Input/Output.<		Mnemonic	Description
26INC+Positive LNA Analog input for Channel C.27AVDD33D3.3 V Analog Supply for Channel D.28IND-Negative LNA Analog Input for Channel D.29IND4Positive LNA Analog Input for Channel D.30AVDD333.3 V Analog Supply.31NCNo Connect. Do not connect to this pin.32NCNo Connect. Do not connect to this pin.33AVDD333.3 V Analog Supply.34NCNo Connect. Do not connect to this pin.35NCNo Connect. Do not connect to this pin.36NCNo Connect. Do not connect to this pin.37NCNo Connect. Do not connect to this pin.38INADC-No Connect. Do not connect to this pin.39INADC-No Connect. Do not connect to this pin.39INADC-No Connect. Do not connect to this pin.31NCNo Connect. Do not connect to this pin.36NCNo Connect. Do not connect to this pin.37NCNo Connect. Do not connect to this pin.38INADC+Positive Analog Input for Alternate Channel D (ADC Only).40AVDD181.8V Analog Supply for ADC.41AVDD18ADC1.8V Analog Supply for ADC.42TEST3Test. Do not use the TEST3 pin; tie it to ground.43ANOUTAnalog Outputs. The ANOUT pin is for debug purposes only. Leave this pin floating.44APOUTAnalog Supply for ADC.45BANDBand Gay Voltage. The BAND pin is for debug purposes only. Leave			
27AVD033D3.3 V Analog Supply for Channel D.28IND-Negative LNA Analog Input for Channel D.29IND+Positive LNA Analog Supply for Channel D.30AVD0333.3 V Analog Supply.31NCNo Connect. Do not connect to this pin.32NCNo Connect. Do not connect to this pin.33AVD0333.3 V Analog Supply.34NCNo Connect. Do not connect to this pin.35NCNo Connect. Do not connect to this pin.36NCNo Connect. Do not connect to this pin.37NCNo Connect. Do not connect to this pin.38INADC-Negative Analog Input for Alternate Channel D (ADC Only).39INADC-Positive Analog Input for Alternate Channel D (ADC Only).40AVD181.8V Analog Supply for ADC.41AVD18ADC1.8V Analog Supply for ADC.42TEST3Test. Do not use the TEST3 pin; tie it to ground.43ANOUTAnalog Outputs. The ANOUT pin is for debug purposes only. Leave this pin floating.44APOUTAnalog Outputs. The ANOUT pin is for debug purposes only. Leave this pin floating.45BANDBand Gap Voltage. The BAND pin is for debug purposes only. Leave this pin floating.46RBIASExternal Resistor. The RBIAS pin sets the internal ADC core bias current.47VREFVoltage Reference Input/Output.48AVDD33CK3.3 V Digital Supply for Clock.59OVD18CLK1.8 V Digital Supply for Clock.54NCNo Conn			
28IND-Negative LNA Analog Input for Channel D.29IND+Positive LNA Analog Input for Channel D.30AVDD333.3 V Analog Supply.31NCNo Connect. Do not connect to this pin.32NCNo Connect. Do not connect to this pin.33AVDD333.3 V Analog Supply.34NCNo Connect. Do not connect to this pin.35NCNo Connect. Do not connect to this pin.36NCNo Connect. Do not connect to this pin.37NCNo Connect. Do not connect to this pin.38INADC-Negative Analog Input for Alternate Channel D (ADC Only).39INADC+Positive Analog Input for Alternate Channel D (ADC Only).34AVDD18ADC1.8 V Analog Supply.41AVDD18ADC1.8 V Analog Supply for ADC.42TEST3Test. Do not use the TEST3 pin; tie it og grund.43ANOUTAnalog Outputs. The APOUT pin is for debug purposes only. Leave this pin floating.44AVDD18ADC1.8 V Analog Supply for ADC.45BANDBand Gap Voltage. The BAND pin is for debug purposes only. Leave this pin floating.46RIACExternal Resistor. The RBIAS pin sets the internal ADC core bias current.47VREFVoltage Reference Input/Voltput.48AVDD33CLK3.3 V Analog Supply for Clock.59CLK+Clock Input True.50CLK+Clock Input True.51CLK+Clock Input True.52NCNo Connect. Do not connect to this pin.			
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61 D7 ADC Data Output 7.	[D9	ADC Data Output 9.
	[D8	ADC Data Output 8.
62 D6 ADC Data Output 6.	[D7	ADC Data Output 7.
	[D6	ADC Data Output 6.
63 D5 ADC Data Output 5.	[D5	ADC Data Output 5.
64 D4 ADC Data Output 4.	[D4	ADC Data Output 4.
65 D3 ADC Data Output 3.	[D3	ADC Data Output 3.
66 D2 ADC Data Output 2.	1	D2	ADC Data Output 2.
67 D1 ADC Data Output 1.	1	D1	ADC Data Output 1.
68 D0 ADC Data Output 0 (LSB).	1	D0	ADC Data Output 0 (LSB).
69 NC No Connect. Do not connect to this pin.	1	NC	No Connect. Do not connect to this pin.
70 NC No Connect. Do not connect to this pin.	1	NC	No Connect. Do not connect to this pin.
71 DVDD33DRV 3.3 V Supply for Output Driver.	1	DVDD33DRV	3.3 V Supply for Output Driver.
72 NC No Connect. Do not connect to this pin.	1	NC	No Connect. Do not connect to this pin.

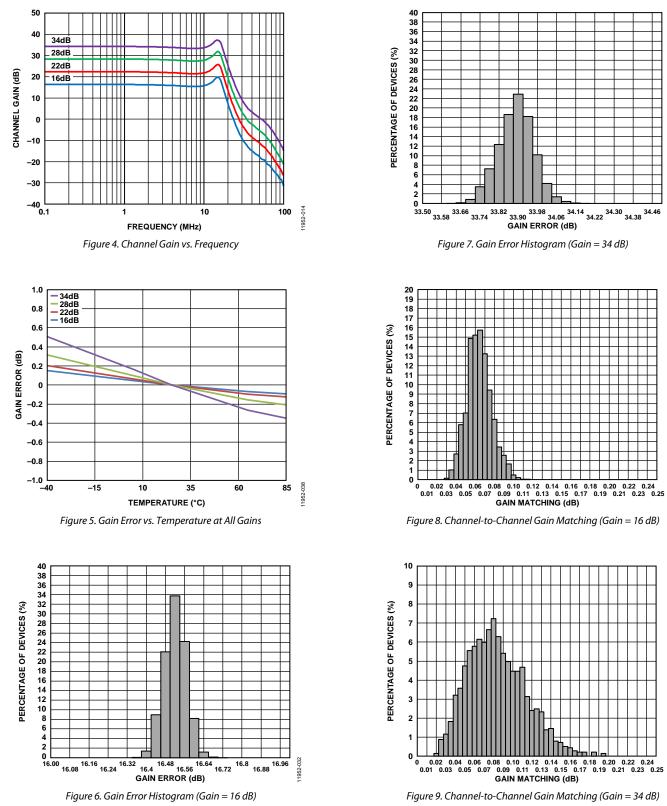
1952-033

952-034

952-03

TYPICAL PERFORMANCE CHARACTERISTICS

 $AVDD18 = AVDD18ADC = 1.8 \text{ V}, AVDD33A = AVDD33B = AVDD33C = AVDD33D = AVDD33 = AVDD33REF = AVDD33CLK = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}, f_S = 72 \text{ MSPS}, R_{IN} = 200 \text{ k}\Omega, \text{ VREF} = 1.024 \text{ V}.$



Data Sheet

6000 4000 -7 -6 -5 -4 -3 -2 11952-015 -1 CODE Figure 10. Output Referred Noise Histogram (Gain = 16 dB)

SLH 4000 3000 NUMBER OF HITS -7 -6 -5 -4 -3 -2 -1 11952-016 CODE

Figure 11. Output Referred Noise Histogram (Gain = 34 dB)

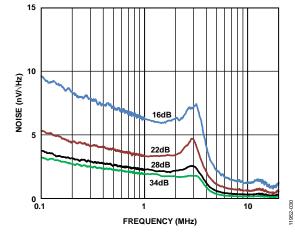
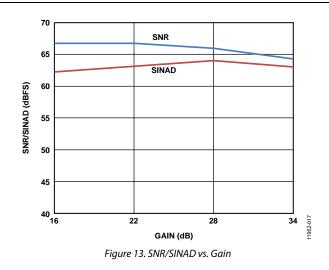
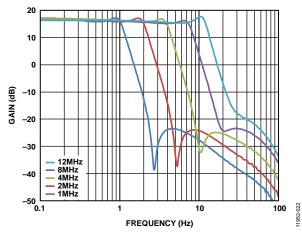


Figure 12. Short-Circuit Input Referred Noise vs. Frequency







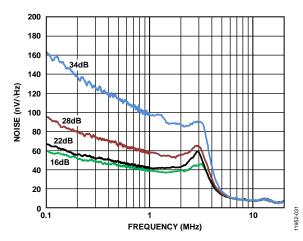
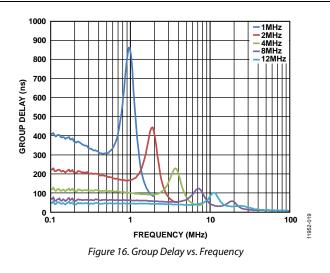
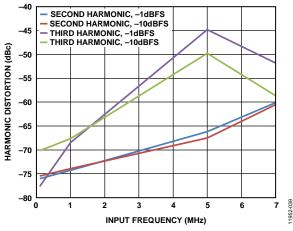
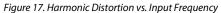
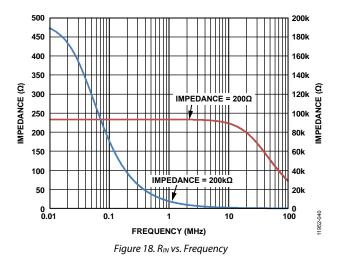


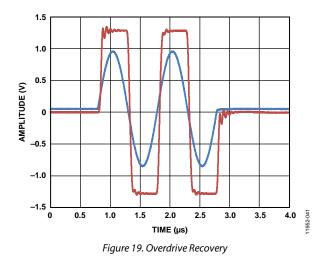
Figure 15. Short-Circuit Output Referred Noise vs. Frequency

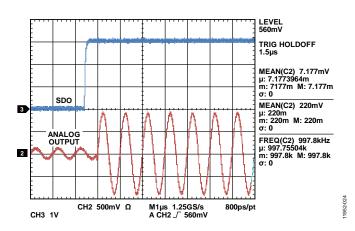


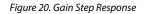


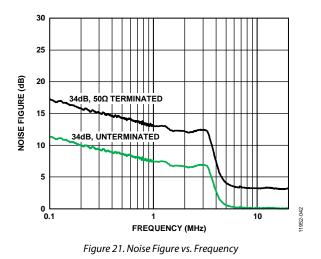




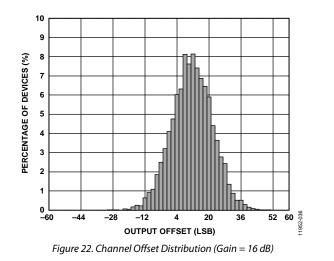


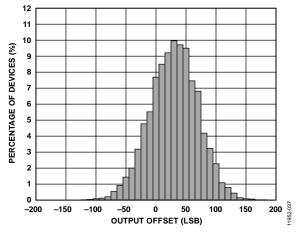


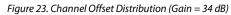




Data Sheet







THEORY OF OPERATION RADAR RECEIVE PATH AFE

The primary application for the AD8285 is high speed ramp, frequency modulated, continuous wave radar (HSR-FMCW radar). Figure 24 shows a simplified block diagram of an HSR-FMCW radar system. The signal chain requires multiple channels, each including a low noise amplifier (LNA), a programmable gain amplifier (PGA), an antialiasing filter (AAF), and an analog-to-digital converter (ADC) with a 12-bit parallel output. The AD8285 provides all of these key components in a single 10×10 LFCSP package.

The performance of each component is designed to meet the demands of an HSR-FMCW radar system. Some examples of

these performance metrics are the LNA noise, PGA gain range, AAF cutoff characteristics, and ADC sample rate and resolution.

The AD8285 includes a multiplexer (mux) in front of the ADC as a cost saving alternative to having an ADC for each channel. The mux automatically switches between each active channel after each ADC sample. The DSYNC output indicates when Channel A data is at the ADC output, and data for each active channel follows sequentially with each clock cycle.

The effective sample rate for each channel is reduced by a factor equal to the number of active channels. The ADC resolution of 12 bits with up to 72 MSPS sampling satisfies the requirements for most HSR-FMCW approaches.

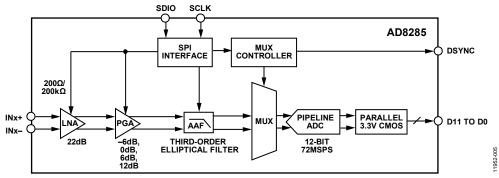
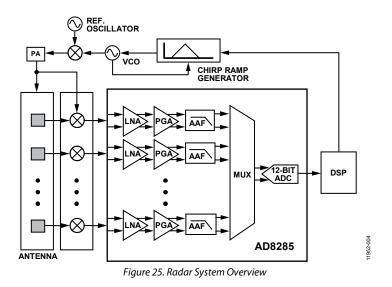


Figure 24. Simplified Block Diagram of a Single Channel



CHANNEL OVERVIEW

Each channel contains an LNA, a PGA, and an AAF in the signal path. The LNA input impedance can be either 200 Ω or 200 k Ω . The PGA has selectable gains that result in channel gains ranging from 16 dB to 34 dB. The AAF has a three-pole elliptical response with a selectable cutoff frequency. The mux is synchronized with the ADC and automatically selects the next active channel after the ADC acquires a sample.

The signal path is fully differential throughout to maximize signal swing and reduce even-order distortion including the LNA, which is designed to be driven from a differential signal source.

Low Noise Amplifier (LNA)

Good noise performance relies on a proprietary ultralow noise LNA at the beginning of the signal chain, which minimizes the noise contributions on the following PGA and AAF. The input impedance can be either 200 Ω or 200 k Ω and is selected through the SPI port or using the ZSEL pin.

The LNA supports differential output voltages as high as 4.0 V p-p with positive and negative excursions of ± 1.0 V from a commonmode voltage of 1.5 V. With the output saturation level fixed, the channel gain sets the maximum input signal before saturation.

Low value feedback resistors and the current driving capability of the output stage allow the LNA to achieve a low input referred noise voltage of $3.5 \text{ nV}/\sqrt{\text{Hz}}$ at a channel gain of 34 dB. The use of a fully differential topology and negative feedback minimizes second-order distortion. Differential signaling enables smaller swings at each output, further reducing third-order distortion.

Recommendation

To achieve the best possible noise performance, it is important to match the impedances seen by the positive and negative inputs. Matching the impedances ensures that any commonmode noise is rejected by the signal path.

Antialiasing Filter (AAF)

The filter that the signal reaches prior to the ADC is used to band limit the signal for antialiasing.

The antialiasing filter uses a combination of poles and zeros to create a third-order elliptical filter. An elliptical filter is used to achieve a sharp roll-off after the cutoff frequency. The filter uses on-chip tuning to trim the capacitors to set the desired cutoff frequency. This tuning method reduces variations in the cutoff frequency due to standard IC process tolerances of resistors and capacitors. The default -3 dB low-pass filter cutoff is 1/3 or 1/4 the ADC sample clock rate. The cutoff can be scaled to 0.7, 0.8, 0.9, 1, 1.1, 1.2, or 1.3 times this frequency through the SPI.

Tuning is normally off to avoid changing the capacitor settings during critical times. The tuning circuit is enabled and disabled through the SPI. Initializing the tuning of the filter must be performed after initial power-up and after reprogramming the filter cutoff scaling or ADC sample rate. Occasional retuning during an idle time is recommended to compensate for temperature drift.

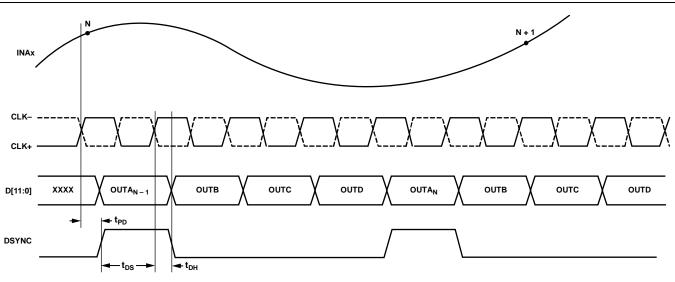
A cutoff range of 1.0 MHz to 12.0 MHz is possible. An example follows:

- Four channels selected: A, B, C, and AUX
- ADC clock: 30 MHz
- Per channel sample rate: 30/4 = 7.5 MSPS
- Default tuned cutoff frequency = 7.5/4 = 1.88 MHz

Mux and Mux Controller

The mux is designed to scan through each active channel automatically. The mux remains on each channel for one clock cycle, then switches to the next active channel. The mux switching is synchronized to the ADC sampling so that the mux switching and channel settling time do not interfere with ADC sampling.

As shown in Table 8, Address 0x0C (FLEX_MUX_CONTROL), Channel A is usually the first converted input; the only exception occurs when Channel AUX is the sole input (see Figure 26 for the timing). Channel AUX is always the last converted input. Unselected codes place the respective channels (LNA, PGA, and filter) in power-down mode unless Address 0x0C, Bit 6 is set to 1. Figure 26 shows the timing of the clock input and data/DSYNC outputs.



NOTES

1. FOR THIS CONFIGURATION, ADDRESS 0x0C, BITS [3:0] IS SET TO 0110 (CHANNEL A, B, C, AND D ENABLED). 2. DSYNC IS ALWAYS ALIGNED WITH CHANNEL A UNLESS CHANNEL A OR CHANNEL AUX IS THE ONLY CHANNEL SELECTED, IN WHICH CASE DSYNC IS NOT ACTIVE.

3. THERE IS A SEVEN-CLOCK CYCLE LATENCY FROM SAMPLING A CHANNEL TO ITS DIGITAL DATA BEING PRESENT ON THE PARALLEL BUS PINS.

ADC

The AD8285 uses a pipelined ADC architecture. The quantized output from each stage is combined into a 12-bit result in the digital correction logic. The pipelined architecture permits the first stage to operate on a new input sample and the remaining stages to operate on preceding samples. Sampling occurs on the rising edge of the clock. The output staging block aligns the data, corrects errors, and passes the data to the output buffers.

CLOCK INPUT CONSIDERATIONS

For optimum performance, clock the AD8285 sample clock inputs (CLK+ and CLK-) with a differential signal. This signal is typically ac-coupled into the CLK+ and CLK- pins via a transformer or by using capacitors. These pins are biased internally and require no additional bias.

Figure 27 shows the preferred method for clocking the AD8285. A low jitter clock source, such as the Valpey Fisher oscillator VFAC3-BHL-50MHz, is converted from single ended to differential using an RF transformer. The back-to-back Schottky diodes across the secondary transformer limit clock excursions into the AD8285 to approximately 0.8 V p-p differential. This helps prevent the large voltage swings of the clock from feeding through to other portions of the AD8285, and it preserves the fast rise and fall times of the signal, which are critical to low jitter performance.

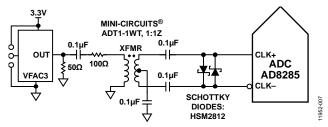


Figure 27. Transformer-Coupled Differential Clock

Figure 26. Data and DSYNC Timing

If a low jitter clock is available, another option is to ac-couple a differential PECL or LVDS signal to the sample clock input pins as shown in Figure 28 and Figure 29. The AD951x/AD952x family of clock drivers offers excellent jitter performance.

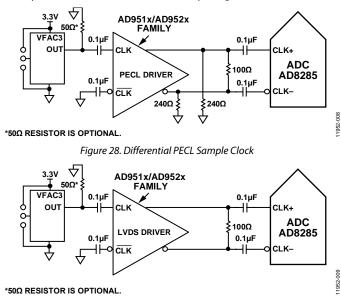
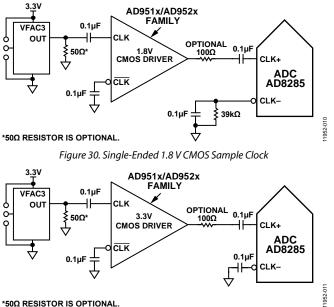


Figure 29. Differential LVDS Sample Clock

In some applications, it is acceptable to drive the sample clock inputs with a single-ended CMOS signal. In such applications, drive CLK+ directly from a CMOS gate, and bypass the CLK– pin to ground with a 0.1 μ F capacitor in parallel with a 39 k Ω resistor (see Figure 30). Although the CLK+ input circuit supply is AVDD18, this input is designed to withstand input voltages of up to 3.3 V, making the selection of the drive logic voltage very flexible. The AD951x/AD952x family of devices can be used to provide 3.3 V inputs (see Figure 31). In this case, 39 k Ω resistor is not needed.

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*50Ω RESISTOR IS OPTIONAL.

Figure 31. Single-Ended 3.3 V CMOS Sample Clock

CLOCK DUTY CYCLE CONSIDERATIONS

Typical high speed ADCs use both clock edges to generate a variety of internal timing signals. As a result, these ADCs may be sensitive to the clock duty cycle. Commonly, a 5% tolerance is required on the clock duty cycle to maintain dynamic performance characteristics. The AD8285 contains a duty cycle stabilizer (DCS) that retimes the nonsampling edge, providing an internal clock signal with a nominal 50% duty cycle. The DCS allows a wide range of clock input duty cycles without affecting the performance of the AD8285.

When the DCS is on, noise and distortion performance are nearly flat for a wide range of duty cycles. However, some applications may require the DCS function to be off. If so, keep in mind that the dynamic range performance can be affected when operating in this mode. See Table 8 for more information about using this feature.

The duty cycle stabilizer uses a delay-locked loop (DLL) to create the nonsampling edge. As a result, any changes to the sampling frequency require approximately eight clock cycles to allow the DLL to acquire and lock to the new rate.

CLOCK JITTER CONSIDERATIONS

High speed, high resolution ADCs are sensitive to the quality of the clock input. The degradation in SNR at a given input frequency (f_A) due only to aperture jitter (t_I) can be calculated by

SNR Degradation = $20 \times \log 10[1/2 \times \pi \times f_A \times t_J]$

In this equation, the rms aperture jitter represents the root mean square of all jitter sources, including the clock input, analog input signal, and ADC aperture jitter. Intermediate frequency undersampling applications are particularly sensitive to jitter.

Treat the clock input as an analog signal in cases where aperture jitter may affect the dynamic range of the AD8285. Separate power supplies for clock drivers from the ADC output driver supplies to avoid modulating the clock signal with digital noise. Low jitter, crystal-controlled oscillators make the best clock sources, such as the Valpey Fisher VFAC3 series. If the clock is generated from another type of source (by gating, dividing, or other methods), retime it by the original clock during the last step.

Refer to the AN-501 Application Note and the AN-756 Application Note for more in-depth information about how jitter performance relates to ADCs.

SDIO PIN

The SDIO pin is required to operate the SPI. It has an internal 30 k Ω pull-down resistor that pulls this pin low and is only 1.8 V tolerant. If applications require that this pin be driven from a 3.3 V logic level, insert a 1 k Ω resistor in series with this pin to limit the current.

SCLK PIN

The SCLK pin is required to operate the SPI port interface. It has an internal 30 k Ω pull-down resistor that pulls this pin low and is both 1.8 V and 3.3 V tolerant.

CS PIN

The \overline{CS} pin is required to operate the SPI port interface. It has an internal 70 k Ω pull-up resistor that pulls this pin high and is both 1.8 V and 3.3 V tolerant.

RBIAS PIN

To set the internal core bias current of the ADC, place a resistor nominally equal to 10.0 k Ω to ground at the RBIAS pin. Using other than the recommended 10.0 k Ω resistor for RBIAS degrades the performance of the device. Therefore, it is imperative that at least a 1.0% tolerance on this resistor be used to achieve consistent performance.

VOLTAGE REFERENCE

A stable and accurate 0.5 V voltage reference is built into the AD8285. This is gained up internally by a factor of 2, setting VREF to 1.024 V, which results in a full-scale differential input span of 2.0 V p-p for the ADC. VREF is set internally by default, but the VREF pin can be driven externally with a 1.0 V reference to achieve more accuracy. However, this device does not support ADC full-scale ranges below 2.0 V p-p.

When applying the decoupling capacitors to the VREF pin, use ceramic low ESR capacitors. These capacitors must be close to the reference pin and on the same layer of the printed circuit board (PCB) as the AD8285. The VREF pin must have both a 0.1 μ F capacitor and a 1 μ F capacitor connected in parallel to the analog ground. These capacitor values are recommended for the ADC to properly settle and acquire the next valid sample.

POWER AND GROUND RECOMMENDATIONS

When connecting power to the AD8285, it is recommended that two separate 1.8 V supplies and two separate 3.3 V supplies be used: one supply each for analog 1.8 V (AVDD18x), digital 1.8 V (DVDD18x), analog 3.3 V (AVDD33x), and digital 3.3 V (DVDD33x). If only one supply is available for both analog and digital, for example, AVDD18x and DVDD18x, route the supply to the AVDD18x first and then tap off and isolate it with a ferrite bead or a filter choke preceded by decoupling capacitors for the DVDD18x. The same is true for the analog and digital 3.3 V supplies. Use several decoupling capacitors on all supplies to cover both high and low frequencies. Locate these capacitors close to the point of entry at the PCB level and close to the device, with minimal trace lengths. When using the AD8285, a single PCB ground plane should be sufficient. With proper decoupling and smart partitioning of the analog, digital, and clock sections of the PCB, optimum performance can be achieved easily.

EXPOSED PADDLE THERMAL HEAT SLUG RECOMMENDATIONS

It is required that the exposed paddle on the underside of the device be connected to a quiet analog ground to achieve the best electrical and thermal performance of the AD8285. Mate an exposed continuous copper plane on the PCB to the AD8285 exposed paddle, Pin 0. The copper plane must have several vias to achieve the lowest possible resistive thermal path for heat dissipation to flow through the bottom of the PCB. Fill or plug these vias with nonconductive epoxy.

To maximize the coverage and adhesion between the device and the PCB, partition the continuous copper pad by overlaying a silkscreen or solder mask to divide the copper pad into several uniform sections. Dividing the copper pad ensures several tie points between the PCB and the EPAD during the reflow process. Using one continuous plane with no partitions only guarantees one tie point between the AD8285 and the PCB. For more detailed information on packaging, and for more PCB layout examples, see the AN-772 Application Note.

SERIAL PERIPHERAL INTERFACE (SPI)

The AD8285 serial peripheral interface allows the user to configure the signal chain for specific functions or operations through a structured register space provided inside the chip. The SPI offers added flexibility and customization depending on the application. Addresses are accessed via the serial port and can be written to or read from via the port. Memory is organized into bytes that can be further divided into fields, as documented in the Memory Map section. Detailed operational information can be found in the AN-877 Application Note, *Interfacing to High Speed ADCs via SPI*.

Three pins define the serial peripheral interface (SPI): SCLK, SDIO, and \overline{CS} . The SCLK (serial clock) pin is used to synchronize the read and write data presented to the device. The SDIO (serial data input/output) pin is a dual-purpose pin that allows data to be sent to and read from the internal memory map registers of the device. The \overline{CS} (chip select bar) pin is an active low control that enables or disables the read and write cycles (see Table 6).

Table 6. Serial Port Pins

Pin	Function
SCLK	Serial clock. The serial shift clock input. SCLK is used to synchronize serial interface reads and writes.
SDIO	Serial data input/output. A dual-purpose pin. The typical role for this pin is as an input or output, depending on the instruction sent and the relative position in the timing frame.
CS	Chip select bar (active low). This control gates the read and write cycles.

The falling edge of the $\overline{\text{CS}}$ in conjunction with the rising edge of the SCLK determines the start of the framing sequence. During an instruction phase, a 16-bit instruction is transmitted, followed by one or more data bytes, which is determined by Bit Field W0 and Bit Field W1. An example of the serial timing and its definitions can be found in Figure 32 and Table 7.

In normal operation, \overline{CS} signals to the device that SPI commands are to be received and processed. When \overline{CS} is brought low, the device processes SCLK and SDIO to process instructions. Normally, \overline{CS} remains low until the communication cycle is complete. However, if connected to a slow device, \overline{CS} can be brought high between bytes, allowing older microcontrollers enough time to transfer data into shift registers. \overline{CS} can be stalled when transferring one, two, or three bytes of data. When W0 and W1 are set to 11, the device enters streaming mode and continues to process data, either reading or writing, until \overline{CS} is taken high to end the communication cycle. This allows complete memory transfers without having to provide additional instructions. Regardless of the mode, if \overline{CS} is taken

high in the middle of any byte transfer, the SPI state machine is reset, and the device waits for a new instruction.

In addition to the operation modes, the SPI port can be configured to operate in different modes. For applications that do not require a control port, the \overline{CS} line can be tied and held high. This what? places the remainder of the SPI pins in their secondary mode, as is defined in the SDIO Pin section and the SCLK Pin section. The \overline{CS} pin can also be tied low to enable 2wire mode. When \overline{CS} is tied low, SCLK and SDIO are the only pins required for communication. Although the device is synchronized during power-up, caution must be exercised when using this mode to ensure that the serial port remains synchronized with the \overline{CS} line. When operating in 2-wire mode, it is recommended to use a 1-, 2-, or 3-byte transfer exclusively. Without an active \overline{CS} line, streaming mode can be entered but not exited.

In addition to word length, the instruction phase determines if the serial frame is a read or write operation, allowing the serial port to be used to both program the chip and read the contents of the on-chip memory. If the instruction is a readback operation, performing a readback causes the serial data input/output (SDIO) pin to change direction from an input to an output at the appropriate point in the serial frame.

Data can be sent in MSB- or LSB-first mode. MSB-first mode is the default at power-up and can be changed by adjusting the configuration register. For more information about this and other features, see the AN-877 Application Note, *Interfacing to High Speed ADCs via SPI*.

HARDWARE INTERFACE

The pins described in Table 6 constitute the physical interface between the programming device of the user and the serial port of the AD8285. The SCLK and \overline{CS} pins function as inputs when using the SPI interface. The SDIO pin is bidirectional, functioning as an input during write phases and as an output during readback.

This interface is flexible enough to be controlled by either serial PROMs or PIC microcontrollers. This flexibility provides the user with an alternative method, other than a full SPI controller, for programming the device (see the AN-812 Application Note).

If the user chooses not to use the SPI interface, these pins serve a dual function and are associated with secondary functions when the $\overline{\text{CS}}$ is strapped to AVDD33 during device power-up. See the SDIO Pinsection and SCLK Pinsection for details on which pin-strappable functions are supported on the SPI pins.

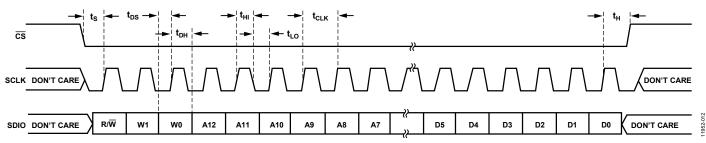


Figure 32. Serial Timing Details

Table 7. Serial Timing Definitions

Parameter	Minimum Timing (ns)	Description
t _{DS}	5	Setup time between the data and the rising edge of SCLK
t _{DH}	2	Hold time between the data and the rising edge of SCLK
t _{CLK}	40	Period of the clock
ts	5	Setup time between CS and SCLK
t _H	2	Hold time between CS and SCLK
t _{HI}	16	Minimum period that SCLK should be in a logic high state
t _{LO}	16	Minimum period that SCLK should be in a logic low state
t _{en_sdio}	10	Minimum time for the SDIO pin to switch from an input to an output relative to the SCLK falling edge (not shown in Figure 32)
tdis_sdio	10	Minimum time for the SDIO pin to switch from an output to an input relative to the SCLK rising edge (not shown in Figure 32)

MEMORY MAP reading the memory map table

Each row in the memory map table has eight address locations. The memory map is roughly divided into three sections: the chip configuration registers map (Address 0x00 and Address 0x01), the device index and transfer registers map (Address 0x05 and Address 0xFF), and the ADC channel functions registers map (Address 0x04 and Address 0x08 to Address 0x2C).

The leftmost column of the memory map indicates the address (hex) number, and the default value is shown in the second rightmost column. The Bit 7 (MSB) column is the start of the default hexadecimal value given. For example, Address 0x09, the GLOBAL_CLOCK register, has a default value of 0x01, meaning that Bit 7 = 0, Bit 6 = 0, Bit 5 = 0, Bit 4 = 0, Bit 3 = 0, Bit 2 = 0, Bit 1 = 0, and Bit 0 = 1, or 0000 0001 in binary. This setting is the default for the duty cycle stabilizer in the on condition. By writing a 0 to Bit 0 of this address followed by an 0x01 to the SW transfer bit in Register 0xFF, the duty cycle stabilizer turns off. It is important to follow each writing sequence with a write to the SW transfer bit to update the SPI registers.

Note that all registers except Register 0x00, Register 0x04, Register 0x05, and Register 0xFF are buffered with a master slave latch and require writing to the transfer bit. For more information on this and other functions, consult the AN-877 Application Note, *Interfacing to High Speed ADCs via SPI*.

LOGIC LEVELS

An explanation of various registers follows: "bit is set" is synonymous with "bit is set to Logic 1" or "writing Logic 1 for the bit." Similarly, "clear a bit" is synonymous with "bit is set to Logic 0" or "writing Logic 0 for the bit."

RESERVED LOCATIONS

Do not write to undefined memory locations except when writing the default values suggested in this data sheet. Consider addresses marked as 0 as reserved, and these addresses must have a 0 written into their registers during power-up.

DEFAULT VALUES

After a reset, critical registers are automatically loaded with default values. These values are indicated in Table 8, where an X refers to an undefined feature.

Table 8. Memory Map Register

Addr. (Hex)	8. Memory Map Regis Register Name	Bit 7 (MSB)	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0 (LSB)	Default Value	Default Notes/ Comments
	onfiguration Registers	(1150)	ысо	DICJ	51(4	DICS	DIC 2		(LJD)	value	comments
0x00	CHIP_PORT_CONFIG	0	LSB first, 1 = on, 0 = off, (default)	Soft reset, 1 = on, 0 = off (default)	1	1	Soft reset, 1 = on, 0 = off (default)	LSB first, 1 = on, 0 = off (default)	0	0x18	Mirror the nibbles so that LSB- or MSB-first mode is set correct regardless of shift mode.
0x01	CHIP_ID			(/		, Bits[7:0] DxA2, default)		Read only	The default value is the chip ID assigned to the AD8285. This is a read- only register.	
Device	Index and Transfer Regist		-						r		
0x05	DEVICE_INDEX	X	x	X	X	Data Channel D, 1 = on (default) , 0 = off	Data Channel C, 1 = on (default) , 0 = off	Data Channel B, 1 = on (default), 0 = off	Data Channel A, 1 = on (default), 0 = off	0x0F	Bits are set to determine which on-chip device receives the next write command.
0xFF	DEVICE_UPDATE	x	X	x	x	X	x	X	SW transfer, 1 = on, 0 = off (default)	0x00	Synchronously transfers data from the master shift register to the slave.
Channe	el Functions Registers	-	-								
0x04	FLEX_RES	X	X	X	X	X	X	Reserved	Reserved	0x0F	Reserved. Bits must be set to 0x00.
0x08	GLOBAL_MODES	X	x	x	x	X	X Internal power-down mode, 00 = chip run (default), 01 = full power- down, 11 = reset		0x00	Determines the power- down mode (global).	
0x09	GLOBAL_CLOCK	x	x	X	x	x	x	x	Duty cycle stabilizer, 1 = on (default), 0 = off	0x01	Turns the internal duty cycle stabilizer on and off (global).
0x0C	FLEX_MUX_CONTROL	X	Power- down of unused channels, 0 = PD (power- down; default), 1 = power-on	X	x	Mux input active channels, 0000 = A, 0001 = AUX, 0010 = A and B, 0011 = A and AUX, 0100 = A, B, and C, 0101 = A, B, and AUX, 0110 = A, B, C, and D, 0111 = A, B, C, and AUX			0x00	Selects the mux input channels to use and specifies whether to power down unused channels.	

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Addr. (Hex)	Register Name	Bit 7 (MSB)	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0 (LSB)	Default Value	Default Notes/ Comments
0x0D	FLEX_TEST_IO	00 = off 01 = off alter 10 = on, s 11 = on,	st mode, (default), n, single rnate, ingle once, alternate nce	Reset PN long gen, 1 = on, 0 = off (default)	Reset PN short gen, 1 = on, 0 = off (default)	0	0000 = 0 0001 = mi 0010 = +fu 0011 = -fu 100 = check 0111 = PN si 1100 = PN si 11 = one-/zi 1000 = 1 1001 = 1-bi 1010 = 1011 = 0 0 = mixed bit	de—see Ta ff (default,) dscale short II-scale shor erboard out equence lor equence lor equence sho ero-word toq user input, t/0-bit toggl : 1× sync, ne bit high, t frequency (UTPUT_MO	t, put, g, rt, ggle, e, format	0x00	When this register is set, the test data is placed on the output pins in place of normal data. (local, except for PN sequence).
0x0F	FLEX_CHANNEL_INPUT	0011 0011 0 0 0 0 0 1 1 1 1 1 1 1 1 1 1	ter cutoff freq $0000 = 1.3 \times 1/$ $0001 = 1.2 \times 1/$ $0010 = 1.1 \times 1/$ $= 1.0 \times 1/4 \times 1/$ $1000 = 0.9 \times 1/$ $0101 = 0.8 \times 1/$ 0111 = not a $0000 = 1.3 \times 1/$ $0010 = 1.2 \times 1/$ $0010 = 1.1 \times 1/$ $0010 = 1.0 \times 1/$ $1010 = 0.9 \times 1/$ $1010 = 0.7 \times 1/$ 1110 = not a	/4 × Ísamplech /4 × Ísamplech /4 × Ísamplech /4 × Ísamplech /4 × Ísamplech /4 × Ísamplech /4 × Ísamplech /3 × Ísamplech	6 17 17 17 17 17 17 17 17 17 17 17 17 17	X	X	X	X	0x30	Low-pass filter cutoff (global). f _{SAMPLECH} = ADC sample rate/ number of active channels. Note that the absolute range is limited to 1.0 MHz to 12.0 MHz.
0x10	FLEX_OFFSET	x	X	6-bit LNA offset adjustment, 00 0000 for LNA bias high, 01 1111 for LNA mid to high, 10 0000 for LNA mid to low (default), 10 0001 for LNA bias low			0x20	LNA force offset correction (local).			
0x11	FLEX_GAIN_1	x	X	Х	X	X 010 = 16 dB (default), 011 = 22 dB, 100 = 28 dB, 101 = 34 dB		0x02	Total LNA + PGA gain adjustment (local)		
0x12	FLEX_BIAS_CURRENT	x	x	X	X	X	X LNA bias, 00 = high, 01 = mid to high (default), 10 = mid to low, 11 = low		0x09	LNA bias current adjustment (global).	
0x14	FLEX_OUTPUT_MODE	X	X	X	X	x	1 = output invert (local)	(def 1 = two	et binary ault), s comple- (global)	0x00	Configures the outputs and the format of the data.
0x15	FLEX_OUTPUT_ ADJUST	0 = enable Data Bits[11:0], 1 = disable Data Bits[11:0]	X	X	X		0000	ive current,) = low, , gh (default)		0x0F	Used to select output drive strength to limit the noise added to the channels by output switching.

Addr. (Hex)	Register Name	Bit 7 (MSB)	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0 (LSB)	Default Value	Default Notes/ Comments
0x18	FLEX_VREF	x	0 = internal reference, 1 = external reference	X	x	x	x	01 = 10 =	0.625 V, 0.750 V, 0.875 V, 4 V (default)	0x03	Select internal reference (recommende d default) or external reference (global); adjust internal reference.
0x19	FLEX_USER_PATT1_ LSB	B7	B6	B5	B4	B3	B2	B1	BO	0x00	User-defined Pattern 1, LSB
0x1A	FLEX_USER_PATT1_ MSB	B15	B14	B13	B12	B11	B10	B9	B8	0x00	User-defined Pattern 1, MSB
0x1B	FLEX_USER_PATT2_ LSB	B7	B6	B5	B4	B3	B2	B1	BO	0x00	User-defined Pattern 2, LSB
0x1C	FLEX_USER_PATT2_ MSB	B15	B14	B13	B12	B11	B10	B9	B8	0x00	User-defined Pattern 2, MSB
0x2B	FLEX_FILTER	x	Enable automati c low- pass tuning, 1 = on (self- clearing)	x	x	x	x	X	x	0x00	Refer to the Antialiasing Filter (AAF) section.
0x2C	CH_IN_IMP	x	X	Х	x	X	X	x	$0 = 200 \Omega$ (default), 1 = $200 k\Omega$	0x00	Input impedance adjustment (global).

Table 9. Flexible Output Test Modes

Output Test Mode Bit Sequence	Pattern Name	Digital Output Word 1	Digital Output Word 2	Subject to Data Format Select
0000	Off (default)	Not applicable	Not applicable	Not applicable
0001	Midscale short	1000 0000 0000	Same	Yes
0010	+Full-scale short	1111 1111 1111	Same	Yes
0011	–Full-scale short	0000 0000 0000	Same	Yes
0100	Checkerboard output	1010 1010 1010	0101 0101 0101	No
0101	PN sequence long	Not applicable	Not applicable	Yes
0110	PN sequence short	Not applicable	Not applicable	Yes
0111	One-/zero-word toggle	1111 1111 1111	0000 0000 0000	No
1000	User input	Register 0x19 to Register 0x1A	Register 0x1B to Register 0x1C	No
1001	1-bit/0-bit toggle	1010 1010 1010	Not applicable	No
1010	1× sync	0000 0011 1111	Not applicable	No
1011	One bit high	1000 0000 0000	Not applicable	No
1100	Mixed bit frequency	1010 0011 0011	Not applicable	No

APPLICATION DIAGRAMS

The typical application diagrams for the AD8285 are shown in Figure 33 and Figure 34. As discussed in the Channel Overview section, the maximum signal swing and the minimum third-order distortion can be achieved when the AD8285 is driven with a fully differential source. The typical connections for this configuration are shown in Figure 33.

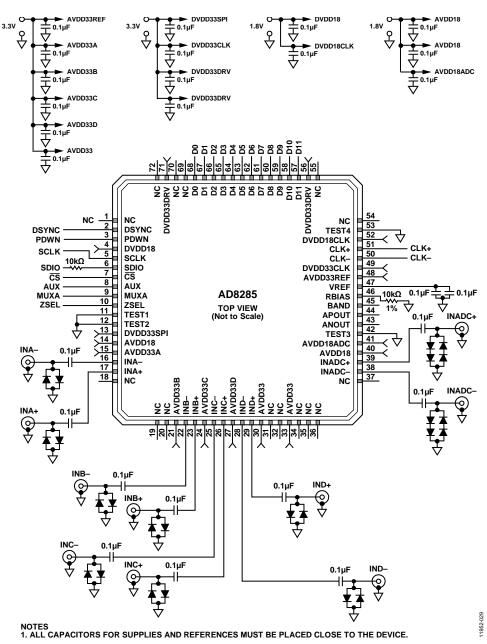


Figure 33. Differential Inputs Application Diagram

The AD8285 can also be driven with a single-ended source, as shown in Figure 34. In this configuration, the negative analog input of each channel is grounded through a resistor and a 0.1 μ F capacitor. For optimal operation, this resistor must match the output impedance of the input driver.

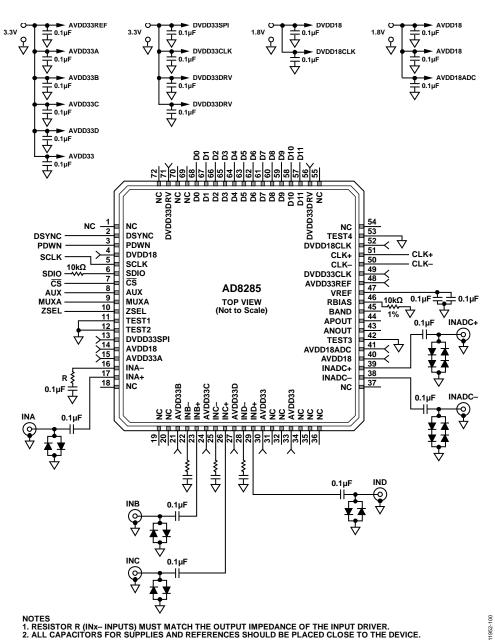
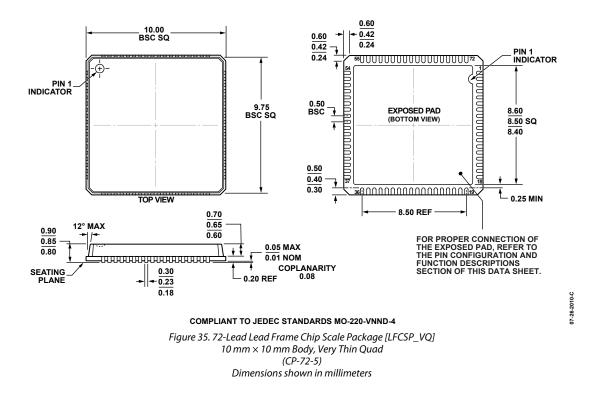


Figure 34. Single-Ended Inputs Application Diagram

OUTLINE DIMENSIONS



ORDERING GUIDE

Model ^{1, 2}	Temperature Range	Package Description	Package Option
AD8285WBCPZ-RL	-40°C to +105°C	72-Lead LFCSP_VQ, 13"Tape and Reel	CP-72-5
AD8285WBCPZ	-40°C to +105°C	72-Lead LFCSP_VQ	CP-72-5

¹ Z = RoHS Compliant Part.

 2 W = Qualified for Automotive Applications.

AUTOMOTIVE PRODUCTS

The AD8285WBCPZ models are available with controlled manufacturing to support the quality and reliability requirements of automotive applications. Note that these automotive models may have specifications that differ from the commercial models; therefore, designers should review the Specifications section of this data sheet carefully. Only the automotive grade products shown are available for use in automotive applications. Contact your local Analog Devices account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for this model.

NOTES

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